

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JUNFENG ZHANG	04/26/2019
JINWEN MO	04/26/2019
JIE DONG	04/26/2019
RECEIVING PARTY DATA	
Name:	HUIZHOU FORYOU MEDICAL DEVICES CO., LTD.
Street Address:	NO.1 SHANGXIA NORTH ROAD
Internal Address:	DONGJIANG HI-TECH INDUSTRIAL PARK
City:	HUIZHOU
State/Country:	CHINA
Postal Code:	516000
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16435559
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	310-497-0181
Email:	cliffordchiapc@outlook.com
Correspondent Name:	CLIFFORD O CHI
Address Line 1:	300 W VALLEY BLVD #609
Address Line 4:	ALHAMBRA, CALIFORNIA 91803
ATTORNEY DOCKET NUMBER:	207-PAUS1910332
NAME OF SUBMITTER:	CLIFFORD O. CHI
SIGNATURE:	/Clifford O. Chi/
DATE SIGNED:	06/10/2019
Total Attachments: 2	
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ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned inventor(s) (hereinafter as "ASSIGNOR") identified as below hereby sells, assigns, transfers, and sets over to **Huizhou Foryou Medical Devices Co., Ltd. of No.1 Shangxia North Road, Dongjiang Hi-tech Industrial Park, Huizhou, Guangdong 516005 China** (hereinafter as "ASSIGNEE"), its successors and assigns, the entire right, title and interest in and to the invention known as

**ANTIBACTERIAL WOUND DRESSING, METHOD FOR PREPARING THE SAME,
AND USE THEREOF**

(hereinafter as "INVENTION"), for which a United States Patent Application was executed concurrently herewith or, if not so executed, was:

- a. executed on ();
- b. filed on (), Application Serial No. (); or
- c. established by PCT International Patent Application No.

and all rights and privileges under any Letters Patent which may be granted thereon, including all rights, if any, to sue for past infringement.

The ASSIGNOR hereby agrees without charge to said ASSIGNEE but at its expense to execute all necessary papers to be used in connection with the above-identified application and any additional, substitute, continuing, divisional, reexamination, or reissue applications, as the ASSIGNEE may deem necessary or expedient; to execute all papers in connection with any interference or other legal or quasi-legal proceedings relating to the above-identified application or any additional, substitute, continuing, divisional, reexamination, reissue applications thereof; to cooperate with the ASSIGNEE in every way possible in obtaining evidence and going forward in any such proceedings; and to perform all other affirmative acts which may be necessary or desirable to obtain a grant of a valid patent for said INVENTION.

The ASSIGNOR hereby agrees to communicate to the ASSIGNEE, or its representatives, any facts known to the ASSIGNOR respecting said INVENTION, and testify in any legal proceedings, sign all lawful papers, execute all necessary assignment papers to cause any and all Letters Patent to be issued to the ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid the ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said INVENTION.

The ASSIGNOR hereby authorizes and requests the Commissioner of the United States Patent and Trademark Office to issue any and all Letters Patent that may be granted upon any patent application for the INVENTION or any additional, substitute, continuing, or divisional applications thereof to the ASSIGNEE, its successors and assigns.

ASSIGNMENT (CONTINUED)

The ASSIGNOR hereby covenants and warrants that the ASSIGNOR has full right to convey the entire right, title and interest in and to said INVENTION by this assignment, free of any encumbrances and that no other agreement has been or will be executed in conflict herewith.

Signature of Inventor 1 张俊丰 Executed Date 2019.4.26
Printed Name ZHANG, Junfeng
Residing at No.1 Shangxia North Road, Dongjiang Hi-tech Industrial Park, Huizhou,
Guangdong 516005 China

Signature of Inventor 2 莫金文 Executed Date 2019.4.26
Printed Name MO, Jinwen
Residing at No.1 Shangxia North Road, Dongjiang Hi-tech Industrial Park, Huizhou,
Guangdong 516005 China

Signature of Inventor 3 董杰 Executed Date 2019.4.26
Printed Name DONG, Jie
Residing at No.1 Shangxia North Road, Dongjiang Hi-tech Industrial Park, Huizhou,
Guangdong 516005 China